

SYMPOSIUM:
The Greening of Electronics in a Global Economy

Hosted by:

California Department of Toxic Substances Control (DTSC)

Organized by:

Intertek & DTSC

Date:

February 19, 2009

Topic:

What are different nations and states doing to enforce environmental requirements regarding hazardous substances in consumer electronics? What measures and quality assurance systems have electronics manufacturers implemented to comply with regulatory requirements? What are the global prospects for greening the electronics supply chain? This symposium -- intended for industry, regulators, and the interested public -- will address all of these questions.

Proposed Agenda:

Time	Agenda Item	Speaker
8:00 – 8:30	Registration	
8:30 – 8:35	Welcome	Joel Pekay, Intertek
8:35 – 8:40	Opening remarks	Maureen Gorsen , DTSC Director
8:40 – 8:50	Introduction of topic and keynote	Claudia Polsky , DTSC
8:50 – 9:35	Keynote	Brian Krzanich , Intel
9:35 – 9:50	Morning Break	
9:50 – 10:30	Good Practices in Global Compliance	Ruud Overbeek , Intertek
10:30 – 11:15	Global Supply Chain Compliance	Judy Glazer , Hewlett Packard
11:15 – 12:00	Trends and a Brief Update	Ken Rivlin , Allen & Overy
12:00 – 1:00	Lunch Break	
1:00 – 1:45	The Evolution of Green Electronics	Joe Johnson , P.E., Cisco Systems
1:45 – 2:30	EU Compliance Update	Göran Gabling , Swedish KEMI
2:30 – 2:45	Afternoon Break	
2:45 – 3:30	European Compliance Enforcement	Henrik Hagen Olesen , Danish EPA
3:30 – 4:15	Life Cycle Analysis	Julie Schoenung , U.C. Davis
4:15 – 4:45	Canadian Restrictions and Standardization	Walter Jager, Intertek
4:45 – 5:00	Closing and Q&A	CA DTSC and Joel Pekay

Location:

Byron Sher Auditorium
California EPA Headquarters
1001 'I' Street
Sacramento, CA 95812

Disclaimer: In an effort to foster the free exchange of information, and scientific and technical advances in regards to sustainable electronics manufacturing, DTSC, in cooperation with Intertek, is hosting this symposium. The information presented represents the views of the participants, and has not received formal peer review. Therefore, this information does not necessarily reflect the views of DTSC, Intertek, or other participating organizations, and no official endorsement should be inferred. The information is not intended, nor can it be relied upon, to create any rights enforceable by any party in litigation with the United States, State of California or any other party. Use or mention of trade names does not constitute an endorsement or recommendation for use. Errors and omissions in the information will be corrected as they are found and time permits.